

/ Descriptions

TO-92 PNP Silicon PNP transistor in a TO-92 Plastic Package.

/ Features

h_{FE} ,
Low noise, high h_{FE} , high breakdown voltage.

/ Applications

Low noise audio amplifier application.

/ Equivalent Circuit



/ Pinning



PIN1 Base PIN 2 Collector PIN 3 Emitter

/ h_{FE} Classifications & Marking

h_{FE} Classifications Symbol	Y	GR	BL
h_{FE} Range	120~240	200~400	350~700

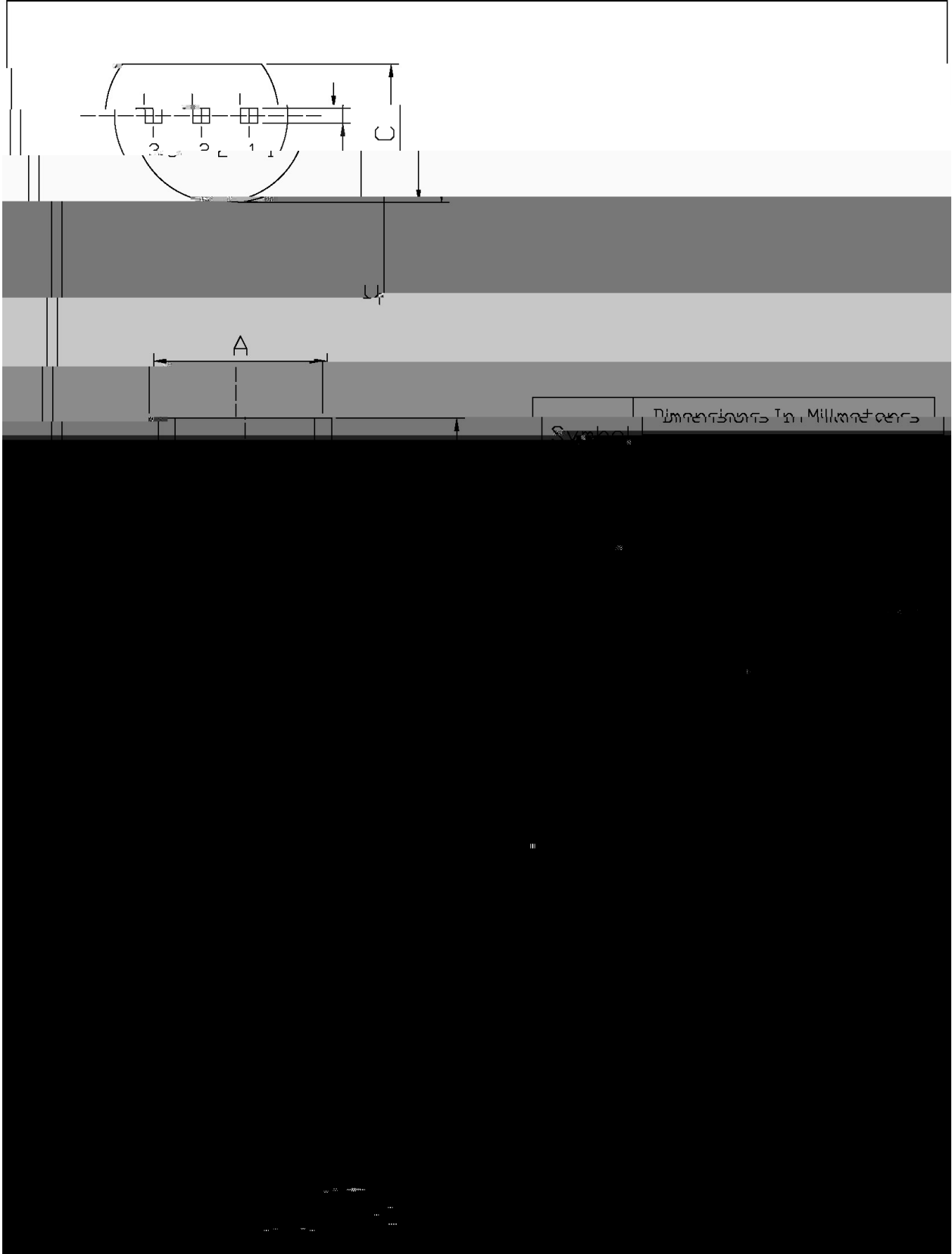
Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-120	V
Collector to Emitter Voltage	V_{CEO}	-120	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current - Continuous	I_C	-100	mA
Collector Power Dissipation	P_C	625	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C = -1.0mA$ $I_B = 0$	-120			V
Collector to Base Breakdown Voltage	V_{CBO}	$I_C = 100\mu A$ $I_E = 0$	-120			V
Emitter to Base Breakdown Voltage	V_{EBO}	$I_E = 100\mu A$ $I_C = 0$	-5.0			V

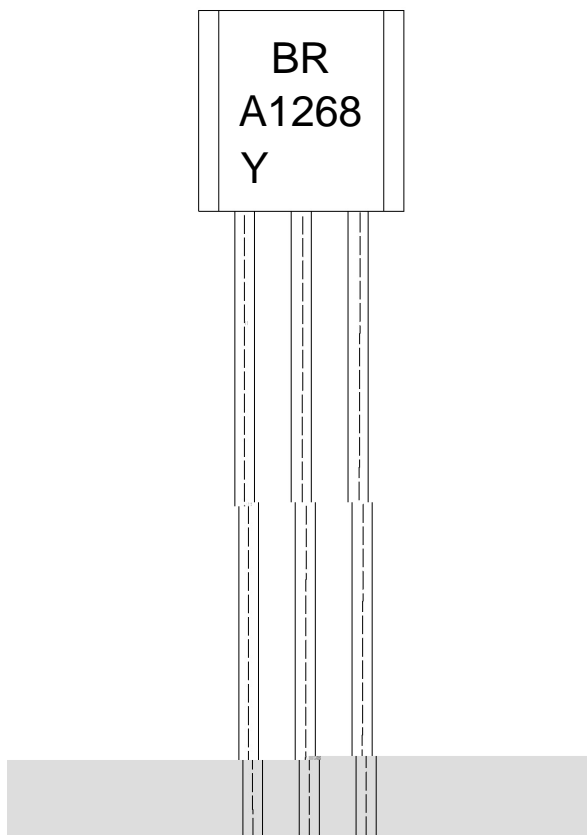
/ Package Dimensions

T0-92

Unit: mm



/ Marking Instructions



BR:

A1268

Y: h_{FE}

Note:

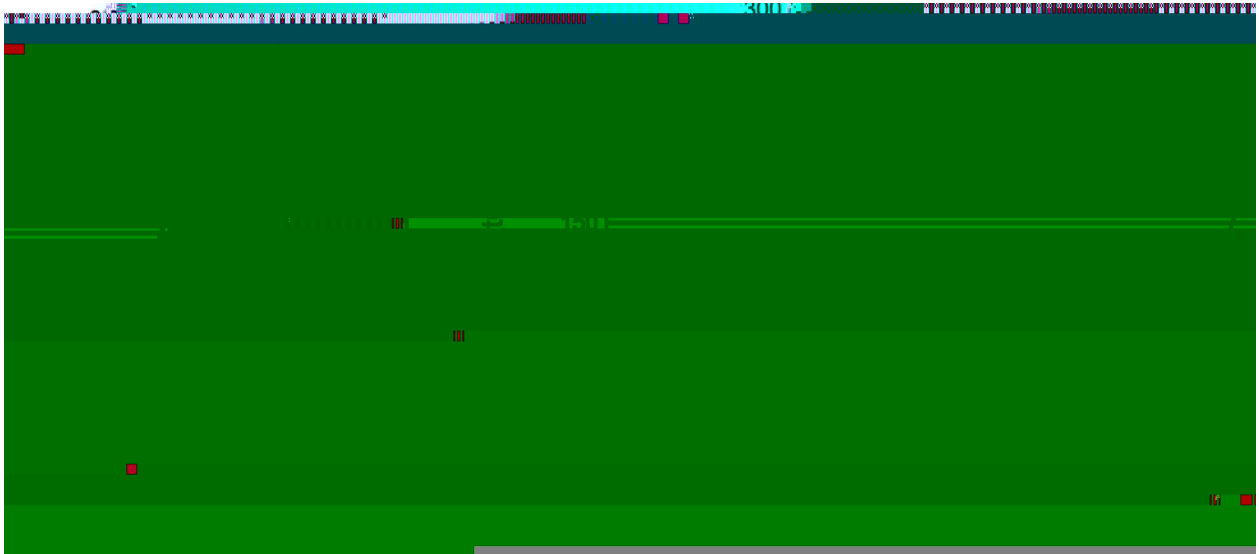
BR: Company Code.

A1268: Product Type.

Y: h_{FE} Classifications Symbol

****: Lot No. Code,code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



- | | | | | | |
|---|-------|-----|-----------|--------|---|
| 1 | 25 | 150 | 60 | 90sec; | Note: |
| 2 | 255±5 | | 5±0.5sec; | | 1.Preheating:25~150 , Time:60~90sec. |
| 3 | | 2 | 10 | /sec. | 2.Peak Temp.:255±5 , Duration:5±0.5sec. |
| | | | | | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270±5 10±1 sec. Temp:270±5 Time:10±1 sec

/ Packaging SPEC.

/ BULK

Package Type	Units					Dimension (unit mm3)		

/ AMMO

Package Type	Units					Dimension (unit mm3)		

/ Notices